Configurable Multifunction Gate

The NLX1G98 MiniGate $^{\text{M}}$ is an advanced high-speed CMOS multifunction gate. The device allows the user to choose logic functions MUX, AND, OR, NAND, NOR, INVERT and BUFFER. The device has Schmitt-trigger inputs, thereby enhancing noise immunity.

The NLX1G98 input and output structures provide protection when voltages up to 7.0 V are applied, regardless of the supply voltage.

Features

- High Speed: $t_{PD} = 3.4 \text{ ns (Typ)} @ V_{CC} = 5.0 \text{ V}$
- Low Power Dissipation: $I_{CC} = 1 \mu A$ (Maximum) at $T_A = 25^{\circ}C$
- Power Down Protection Provided on inputs
- Balanced Propagation Delays
- Overvoltage Tolerant (OVT) Input and Output Pins
- Ultra-Small Packages
- These are Pb-Free Devices



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MARKING DIAGRAMS



ULLGA6 1.0 x 1.0 CASE 613AD





ULLGA6 1.2 x 1.0 CASE 613AE



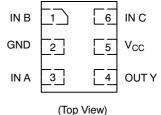


ULLGA6 1.45 x 1.0 CASE 613AF



A = Specific Device Code M = Date Code

PIN ASSIGNMENTS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

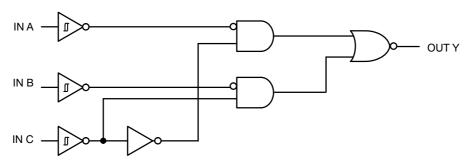


Figure 1. Function Diagram

PIN ASSIGNMENT

| 1 | IN B |
|---|-----------------|
| 2 | GND |
| 3 | IN A |
| 4 | OUT Y |
| 5 | V _{CC} |
| 6 | IN C |

FUNCTION TABLE*

| | Input | | | | | |
|---|-------|---|---|--|--|--|
| Α | В | С | Υ | | | |
| L | L | L | Н | | | |
| L | L | Н | Н | | | |
| L | Н | L | L | | | |
| L | Н | Н | Н | | | |
| Н | L | L | Н | | | |
| Н | L | Н | L | | | |
| Н | Н | L | L | | | |
| Н | Н | Н | L | | | |

^{*}To select a logic function, please refer to "Logic Configurations section".

LOGIC CONFIGURATIONS

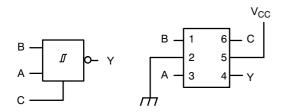


Figure 2. 2-Input MUX with Output Inverted

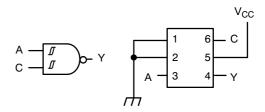


Figure 3. 2-Input NAND (When B = "L")

 V_{CC}

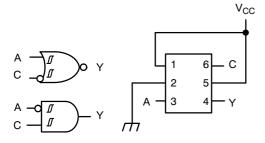


Figure 4. 2-Input NOR with Input C Inverted (When B = "H")

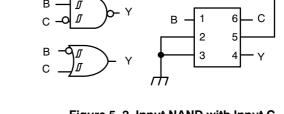


Figure 5. 2-Input NAND with Input C Inverted (When A = "L")

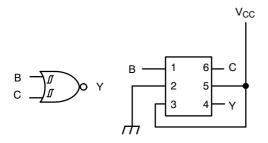


Figure 6. 2-Input NOR (When A ="H")

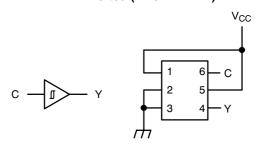


Figure 7. Buffer (When A = "L" and B = "H")

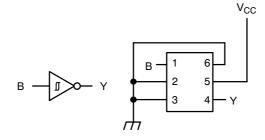


Figure 8. Inverter (When A = C = "L")

MAXIMUM RATINGS

| Symbol | Parameter | | Value | Unit |
|----------------------|---|----|----------------------|------|
| V _{CC} | DC Supply Voltage | | -0.5 to +7.0 | V |
| V _{IN} | DC Input Voltage | | -0.5 to +7.0 | V |
| V _{OUT} | DC Output Voltage | | -0.5 to +7.0 | V |
| I _{IK} | DC Input Diode Current V _{IN} < G | ND | -50 | mA |
| I _{OK} | DC Output Diode Current V _{OUT} < G | ND | -50 | mA |
| ΙO | DC Output Source/Sink Current | | ±50 | mA |
| I _{CC} | DC Supply Current Per Supply Pin | | ±100 | mA |
| I _{GND} | DC Ground Current per Ground Pin | | ±100 | mA |
| T _{STG} | Storage Temperature Range | | -65 to +150 | °C |
| T_L | Lead Temperature, 1 mm from Case for 10 Seconds | | 260 | °C |
| T_J | Junction Temperature Under Bias | | 150 | °C |
| MSL | Moisture Sensitivity | | Level 1 | |
| F _R | Flammability Rating Oxygen Index: 28 to | 34 | UL 94 V-0 @ 0.125 in | |
| V _{ESD} | ESD Withstand Voltage Human Body Model (Note Machine Model (Note Charged Device Model (Note | 3) | >2000 >200 N/A | V |
| I _{LATCHUP} | Latchup Performance Above V _{CC} and Below GND at 125°C (Note 5) | | ±500 | mA |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm@by@1 inch, 2 ounce copper trace no air flow.

- Tested to EIA/JESD22-A114-A.
 Tested to EIA/JESD22-A115-A.
- 4. Tested to JESD22-C101-A.
- Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|------------------|---|-------------|----------------------------------|------|
| V _{CC} | Positive DC Supply Voltage | 1.65 | 5.5 | V |
| V _{IN} | Digital Input Voltage | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | 0 | 5.5 | V |
| T _A | Operating Free-Air Temperature | -55 | +125 | °C |
| Δt/ΔV | Input Transition Rise or Fall Rate $ \begin{array}{c} V_{CC} = 2.5 \ V \ \pm \ 0.2 \ V \\ V_{CC} = 3.3 \ V \ \pm \ 0.3 \ V \\ V_{CC} = 5.0 \ V \ \pm \ 0.5 \ V \\ \end{array} $ | 0 0 0 | No Limit No Limit No Limit | nS/V |

DC ELECTRICAL CHARACTERISTICS

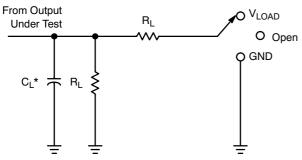
| | | | V _{CC} | - | Γ _A = 25° | С | T _A ≤ | +85°C | | 55°C to 5°C | |
|-----------------|--------------------------------|--|-----------------|--------------------------|----------------------|------|--------------------------|-------|--------------------------|----------------|------|
| Symbol | Parameter | Conditions | (V) | Min | Тур | Max | Min | Max | Min | Max | Unit |
| V_{T+} | Positive | | 1.65 | 0.79 | | 1.16 | | 1.16 | | 1.16 | V |
| | Threshold Voltage | | 2.3 | 1.11 | | 1.56 | | 1.56 | | 1.56 | |
| | | | 3.0 | 1.5 | | 1.87 | | 1.87 | | 1.87 | |
| | | | 4.5 | 2.16 | | 2.74 | | 2.74 | | 2.74 | 1 |
| | | | 5.5 | 2.61 | | 3.33 | | 3.33 | | 3.33 | 1 |
| V _{T-} | Negative | | 1.65 | 0.35 | | 0.62 | 0.35 | | 0.35 | | V |
| | Threshold Voltage | | 2.3 | 0.58 | | 0.87 | 0.58 | | 0.58 | | |
| | Voltage | | 3.0 | 0.84 | | 1.19 | 0.84 | | 0.84 | | |
| | | | 4.5 | 1.41 | | 1.9 | 1.41 | | 1.41 | | |
| | | | 5.5 | 1.78 | | 2.29 | 1.78 | | 1.78 | | |
| V _H | Hysteresis | | 1.65 | 0.30 | | 0.62 | 0.30 | 0.62 | 0.30 | 0.62 | V |
| | Voltage | | 2.3 | 0.40 | | 0.8 | 0.40 | 0.8 | 0.40 | 0.8 | |
| | | | 3.0 | 0.53 | | 0.87 | 0.53 | 0.87 | 0.53 | 0.87 | |
| | | | 4.5 | 0.71 | | 1.04 | 0.71 | 1.04 | 0.71 | 1.04 | |
| | | | 5.5 | 0.8 | | 1.2 | 0.8 | 1.2 | 0.8 | 1.2 | |
| V _{OH} | Minimum High-Level | $V_{IN} = V_{T-MIN} \text{ or } V_{T+MAX}$ $I_{OH} = -50 \mu\text{A}$ | 1.65 - 5.5 | V _{CC} - 0.1 | | | V _{CC} - 0.1 | | V _{CC} - 0.1 | | ٧ |
| | Output Voltage | $V_{IN} = V_{T-MIN}$ or V_{T+MAX} | | | | | | | | | |
| | | I _{OH} = -4 mA | 1.65 | 1.2 | | | 1.2 | | 1.2 | | |
| | | I _{OH} = -8 mA | 2.3 | 1.9 | | | 1.9 | | 1.9 | | |
| | | I _{OH} = -16 mA | 3.0 | 2.4 | | | 2.4 | | 2.4 | | |
| | | I _{OH} = -24 mA | 3.0 | 2.3 | | | 2.3 | | 2.3 | | |
| | | I _{OH} = -32 mA | 4.5 | 3.8 | | | 3.8 | | 3.8 | | |
| V _{OL} | Maximum Low-Level | $V_{IN} = V_{T-MIN} \text{ or } V_{T+MAX}$ $I_{OL} = 50 \mu\text{A}$ | 1.65 - 5.5 | | | 0.1 | | 0.1 | | 0.1 | ٧ |
| | Output Voltage | $V_{IN} = V_{T-MIN}$ or V_{T+MAX} | | | | | | | | | |
| | | I _{OL} = 4 mA | 1.65 | | | 0.45 | | 0.45 | | 0.45 | |
| | | I _{OL} = 8 mA | 2.3 | | | 0.3 | | 0.3 | | 0.3 | 1 |
| | | I _{OL} = 16 mA | 3.0 | | | 0.4 | | 0.4 | | 0.4 | 1 |
| | | I _{OL} = 24 mA | 3.0 | | | 0.55 | | 0.55 | | 0.55 | |
| | | I _{OL} = 32 mA | 4.5 | | | 0.55 | | 0.55 | | 0.55 | |
| I _{IN} | Input Leakage Current | 0 ≤ V _{IN} ≤ 5.5 V | 0 to 5.5 | | | ±0.1 | | ±1.0 | | ±1.0 | μΑ |
| I _{CC} | Quiescent Supply Current | $0 \le V_{IN} \le V_{CC}$ | 5.5 | | | 1.0 | | 10 | | 10 | μΑ |

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$)

| | | | | ٦ | Γ _A = 25°(| ; | T _A ≤ | +85°C | | -55°C 25°C | |
|--------------------|--|---------------------|----------------|-----|-----------------------|------|------------------|-------|-----|---------------|------|
| Symbol | Parameter | V _{CC} (V) | Test Condition | Min | Тур | Max | Min | Max | Min | Max | Unit |
| t _{PLH} , | Propagation Delay, | 1.65 - 1.95 | | 3.2 | 8.9 | 14.4 | 3.2 | 14.4 | 3.2 | 14.4 | ns |
| t _{PHL} | Any Input to Output Y (See Test Circuit) | 2.3 - 2.7 | | 2.0 | 5.2 | 8.3 | 2.0 | 8.3 | 2.0 | 8.3 | |
| | | 3.0 - 3.6 | | 1.5 | 4.0 | 6.3 | 1.5 | 6.3 | 1.5 | 6.3 | |
| | | 4.5 - 5.5 | | 1.1 | 3.4 | 5.1 | 1.1 | 5.1 | 1.1 | 5.1 | |
| C _{IN} | Input Capacitance | | | | 3.5 | | | | | | pF |
| C _{PD} | Power Dissipation Capacitance (Note 6) | 5.0 | f = 10 MHz | | 22 | | | | | | pF |

^{6.} C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the dynamic operating current consumption without load. Average operating current can be obtained by the equation I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no-load dynamic power consumption: P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.

TEST CIRCUIT AND VOLTAGE WAVEFORMS



| S1 |
|------------|
| Open |
| V_{LOAD} |
| GND |
| |

Figure 9. Load Circuit

| | Inp | outs | | | | | |
|-----------------|-----------------|--------------------------------|--------------------|---------------------|-------|---------|------------|
| V _{CC} | VI | t _r /t _f | V_{M} | V _{LOAD} | CL | R_{L} | V_Δ |
| 1.8 V ± 0.15 V | V _{CC} | ≤ 2 ns | V _{CC} /2 | $2 \times V_{CC}$ | 30 pF | 1 kΩ | 0.15 V |
| 2.5 V ± 0.2 V | V _{CC} | ≤ 2 ns | V _{CC} /2 | $2 \times V_{CC}$ | 30 pF | 500 Ω | 0.15 V |
| 3.3 V ± 0.3 V | 3 V | ≤ 2.5 ns | 1.5 V | 6 V | 50 pF | 500 Ω | 0.3 V |
| 5.5 V ± 0.5 V | V _{CC} | ≤ 2.5 ns | V _{CC} /2 | 2 x V _{CC} | 50 pF | 500 Ω | 0.3 V |

^{*}C_L includes probes and jig capacitance.

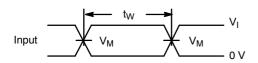


Figure 10. Voltage Waveforms Pulse Duration

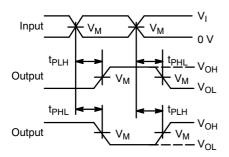


Figure 12. Voltage Waveforms Propagation Delay Times Inverting and Noninverting Outputs

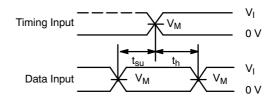


Figure 11. Voltage Waveforms Setup and Hold Times

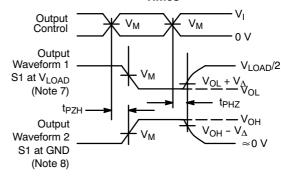


Figure 13. Voltage Waveforms Enable and Disable Times Low- and High-Level Enabling

- 7. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
- 8. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control
- 9. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$.
- 10. The outputs are measured one at a time, with one transition per measurement.
- 11. All parameters are waveforms are not applicable to all devices.

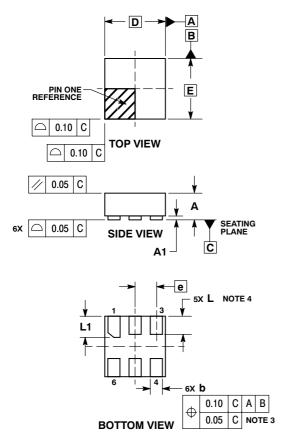
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|-----------------------------|-----------------------|
| NLX1G98AMX1TCG | ULLGA6 - 0.5P (Pb-Free) | 3000 / Tape & Reel |
| NLX1G98BMX1TCG | ULLGA6 - 0.4P (Pb-Free) | 3000 / Tape & Reel |
| NLX1G98CMX1TCG | ULLGA6 - 0.35P (Pb-Free) | 3000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

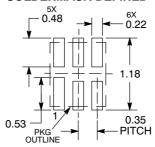
ULLGA6 1.0x1.0, 0.35P CASE 613AD-01 ISSUE A



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
 4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.
- PACKAGE IS ALLOWED.

| _ | MILLIMETERS | | | | |
|-----|-------------|------|--|--|--|
| DIM | MIN | MAX | | | |
| Α | - | 0.40 | | | |
| A1 | 0.00 | 0.05 | | | |
| b | 0.12 | 0.22 | | | |
| D | 1.00 | BSC | | | |
| E | 1.00 | BSC | | | |
| е | 0.35 BSC | | | | |
| L | 0.25 | 0.35 | | | |
| L1 | 0.30 | 0.40 | | | |

MOUNTING FOOTPRINT SOLDERMASK DEFINED*

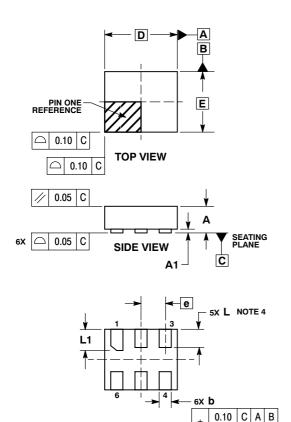


DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

ULLGA6 1.2x1.0, 0.4P CASE 613AE-01 ISSUE A



BOTTOM VIEW

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0.05 C NOTE 3

NOTES:

- ITES:

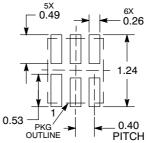
 DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 CONTROLLING DIMENSION: MILLIMETERS. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.

 A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| | MILLIMETERS | | | | | |
|-----|--------------------|------|--|--|--|--|
| DIM | MIN | MAX | | | | |
| Α | | 0.40 | | | | |
| A1 | 0.00 | 0.05 | | | | |
| b | 0.15 | 0.25 | | | | |
| D | 1.20 | BSC | | | | |
| E | 1.00 | BSC | | | | |
| е | 0.40 | BSC | | | | |
| L | 0.25 | 0.35 | | | | |
| L1 | 0.35 | 0.45 | | | | |

MOUNTING FOOTPRINT SOLDERMASK DEFINED*

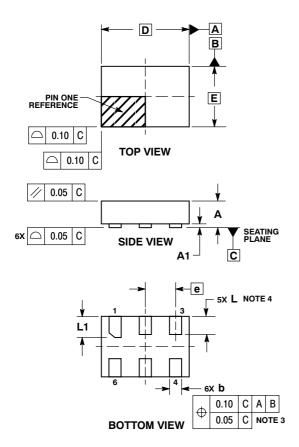


DIMENSIONS: MILLIMETERS

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PACKAGE DIMENSIONS

ULLGA6 1.45x1.0, 0.5P CASE 613AF-01 **ISSUE A**

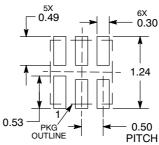


NOTES:

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 CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
- A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| | MILLIMETERS | | | | |
|-----|-------------|------|--|--|--|
| DIM | MIN | MAX | | | |
| Α | | 0.40 | | | |
| A1 | 0.00 | 0.05 | | | |
| b | 0.15 | 0.25 | | | |
| D | 1.45 | BSC | | | |
| E | 1.00 BSC | | | | |
| е | 0.50 BSC | | | | |
| L | 0.25 | 0.35 | | | |
| L1 | 0.30 | 0.40 | | | |

MOUNTING FOOTPRINT SOLDERMASK DEFINED*



DIMENSIONS: MILLIMETERS

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